



**DXT651** 

#### **60V NPN MEDIUM POWER TRANSISTOR IN SOT89**

#### **Features**

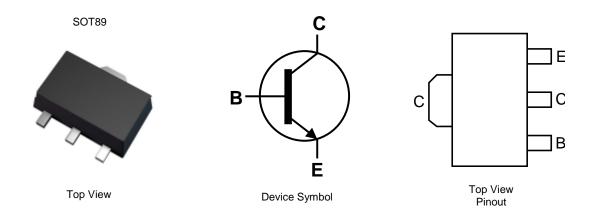
- BV<sub>CEO</sub> > 60V
- I<sub>C</sub> = 3A High Continuous Collector Current
- I<sub>CM</sub> up to 6A Peak Pulse Current
- 2W Power Dissipation
- Low Saturation Voltage V<sub>CE(sat)</sub> < 300mV @ 1A</li>
- Complementary PNP Type: DIODES™ DXT751
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- An automotive-compliant part is available under separate datasheet (<u>DXT651Q</u>)

#### **Mechanical Data**

- Package: SOT89
- Package Material: Molded Plastic. "Green" Molding Compound.
   UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.052 grams (Approximate)
   Max Soldering Temperature +260°C for 30 secs as per JEDEC J-STD-020

#### **Applications**

- Load management functions
- Motor controls
- DC-DC / DC-AC converters



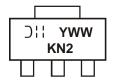
# Ordering Information (Note 4)

Product	DI	Marking	Reel size (inches)	Tape width (mm)	Packing	
Product	Package	Warking	Reel Size (Illiches)	rape widin (min)	Qty.	Carrier
DXT651-13	SOT89	KN2	13	12	2,500	Reel
DXT651-13R	SOT89	KN2	13	12	4,000	Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
- 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# Marking Information



KN2 = Product Type Marking Code
O!! = Manufacturer's Marking Code
YWW = Date Code Marking
Y = Last Digit of Year (ex: 3 = 2023)
WW = Week Code (01 to 53)



#### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	80	V
Collector-Emitter Voltage	$V_{\sf CEO}$	60	V
Emitter-Base Voltage	$V_{EBO}$	5	V
Collector Current	Ιc	3	A
Peak Pulse Collector Current	I <sub>CM</sub>	6	А
Base Current	Ι <sub>Β</sub>	500	mA

# Thermal Characteristics (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Power Dissipation	(Note 5)	р	1	- W	
Power Dissipation	(Note 6)	P <sub>D</sub>	2		
Thermal Resistance, Junction to Ambient Air	(Note 5)	Ъ	125	- °C/W	
mermai Resistance, Junction to Ambient Air	(Note 6)	$R_{ hetaJA}$	62.5		
Thermal Resistance, Junction to Case	(Note 5)	$R_{ heta JC}$	26	°C/W	
Thermal Resistance, Junction to Leads	(Note 7)	$R_{\theta JL}$	6	°C/W	
Operating and Storage Temperature Range	$T_{J}, T_{STG}$	-55 to +150	°C		

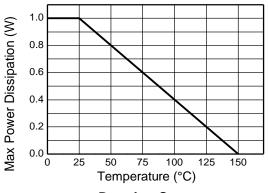
Notes:

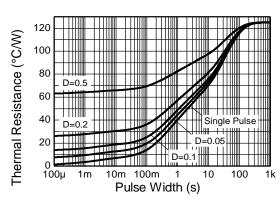
<sup>5.</sup> For a device surface mounted on 15mm x 15mm x 0.6mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions; the device is measured when operating in steady state condition.

<sup>6.</sup> Same as note (5), except the device is mounted on 40mm x 40mm x 1.6mm FR4 PCB. 7. Thermal resistance from junction to solder-point (on the exposed collector pad).



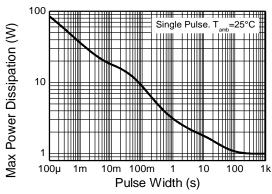
## **Thermal Characteristics and Derating Information**





**Derating Curve** 

**Transient Thermal Impedance** 



**Pulse Power Dissipation** 



#### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	80	_	_	V	$I_C = 100\mu A$
Collector-Emitter Breakdown Voltage (Note 8)	BV <sub>CEO</sub>	60	_	_	V	$I_C = 10mA$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	5	_		V	$I_E = 100\mu A$
Collector-Base Cutoff Current	I <sub>CBO</sub>	_	_	0.1 10	μΑ	V <sub>CB</sub> = 60V V <sub>CB</sub> = 60V, T <sub>A</sub> = +100°C
Emitter-Base Cutoff Current	I <sub>EBO</sub>	_	_	0.1	μΑ	$V_{EB} = 4V$
ON CHARACTERISTICS (Note 8)						
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	_	0.08 0.23	0.3 0.6	V V	$I_C = 1A$ , $I_B = 100mA$ $I_C = 3A$ , $I_B = 300mA$
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>	_	0.85	1.25	V	$I_C = 1A$ , $I_B = 100mA$
Base-Emitter Turn-On Voltage	V <sub>BE(on)</sub>	_	0.8	1	V	$V_{CE} = 2V$ , $I_C = 1A$
DC Current Gain	h <sub>FE</sub>	70 100 80 40	200 200 185 120	 300  	_	$V_{CE} = 2V, I_{C} = 50mA$ $V_{CE} = 2V, I_{C} = 500mA$ $V_{CE} = 2V, I_{C} = 1A$ $V_{CE} = 2V, I_{C} = 2A$
SMALL-SIGNAL CHARACTERISTICS						
Transition Frequency	f <sub>T</sub>	140	200	_	MHz	$V_{CE} = 5V, I_{C} = 100 \text{mA}, f = 100 \text{MHz}$
Output Capacitance	$C_{obo}$		_	30	pF	$V_{CB} = 10V$ , $f = 1MHz$
Switching Times	t <sub>on</sub> t <sub>off</sub>	_	35 230		ns ns	$V_{CC} = 10V, I_C = 500mA,$ $I_{B1} = -I_{B2} = 50mA$

Note:

8. Measured under pulsed conditions. Pulse width ≤ 300µs. Duty cycle ≤ 2%.

## Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

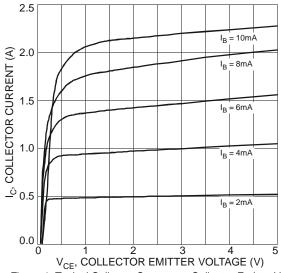


Figure 1 Typical Collector Current vs. Collector-Emitter Voltage

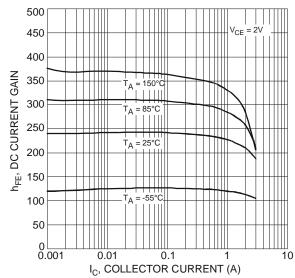


Figure 2 Typical DC Current Gain vs. Collector Current



## Typical Electrical Characteristics (Continued)

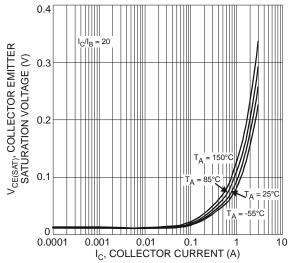


Figure 3 Typical Collector-Emitter Saturation Voltage vs. Collector Current

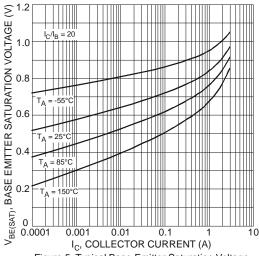


Figure 5 Typical Base-Emitter Saturation Voltage vs. Collector Current

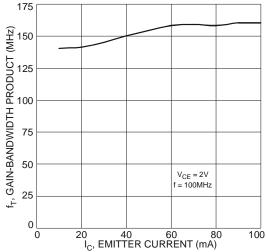


Figure 7 Typical Gain-Bandwidth Product vs. Emitter Current

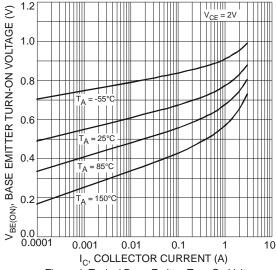


Figure 4 Typical Base-Emitter Turn-On Voltage vs. Collector Current

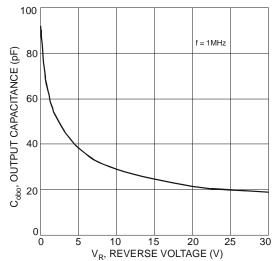
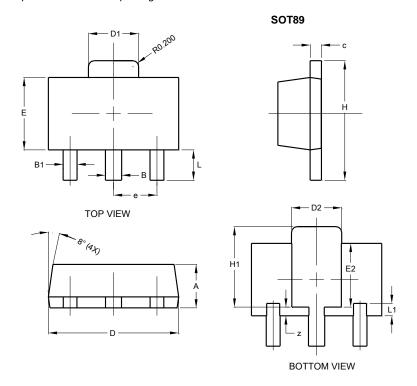


Figure 6 Typical Output Capacitance Characteristics



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

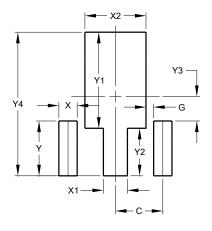


SOT89					
Dim	Min	Max	Тур		
Α	1.40	1.60	1.50		
В	0.50	0.62	0.56		
B1	0.42	0.54	0.48		
С	0.35	0.43	0.38		
D	4.40	4.60	4.50		
D1	1.62	1.83	1.733		
D2	1.61	1.81	1.71		
Е	2.40	2.60	2.50		
E2	2.05	2.35	2.20		
е	1	-	1.50		
Н	3.95	4.25	4.10		
H1	2.63	2.93	2.78		
L	0.90	1.20	1.05		
L1	0.327	0.527	0.427		
Z	0.20	0.40	0.30		
All Dimensions in mm					

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SOT89**



Dimensions	Value		
Dillielisiolis	(in mm)		
С	1.500		
G	0.244		
Х	0.580		
X1	0.760		
X2	1.933		
Υ	1.730		
Y1	3.030		
Y2	1.500		
Y3	0.770		
Y4	4.530		

January 2023



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